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Transistor, N-Channel, Field Effect, Enhancement Mode FDT457N

General Description

These N–Channel enhancement mode power field effect transistors are produced using **onsemi**'s proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on–state resistance, provide superior switching performance. These products are well suited to low voltage, low current applications such as notebook computer power management, battery powered circuits, and DC motor control.

Features

• 5 A, 30 V

 $\begin{aligned} R_{DS(on)} &= 0.06 \ \Omega \ @ \ V_{GS} = 10 \ V \\ R_{DS(on)} &= 0.090 \ \Omega \ @ \ V_{GS} = 4.5 \ V \end{aligned}$

- High Density Cell Design for Extremely Low RDS(ON)
- High Power and Current Handling Capability in a Widely Used Surface Mount Package
- This Device is Pb-Free

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Pa	rameter	Ratings	Unit	
V _{DSS}	Drain-Source Volta	Drain-Source Voltage			
V _{GSS}	Gate-Source Voltag	Gate-Source Voltage - Continuous			
I _D	Maximum	 Continuous (Note 1a) 	5	А	
	Drain Current	– Pulsed	16		
PD	Maximum	(Note 1a)	3	W	
	Power Dissipation	(Note 1b)	1.3		
		(Note 1c)	1.1		
T _J , T _{stg}	Operating and Stora Temperature Range		-65 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

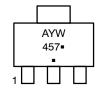
Symbol	Parameter	Ratings	Unit
Reja	Thermal Resistance, Junction-to-Ambient (Note 1a)	42	°C/W
Rejc	Thermal Resistance, Junction-to-Case (Note 1)	12	°C/W

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	$0.06 \ \Omega @ 10 \ V$	5 A
	0.090 Ω @ 4.5 V	



SOT-223 CASE 318H

MARKING DIAGRAM



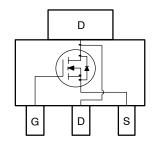
A = Specific Device Code

- Y = Date Code
- W = Work Week
- 457 = Specific Device Code

= Pb-Free Package

(Note: Microdot may be in either location)

PINOUT



ORDERING INFORMATION

Device	Package	Shipping [†]
FDT457N	SOT-223 (Pb-Free)	4000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit			
FF CHARACTERISTICS									
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I _D = 250 µA	30	-	-	V			
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA,Referenced to 25°C	-	35	-	mV/°C			
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA			
		$V_{DS}=24~V,~V_{GS}=0~V,~T_{J}=55^{\circ}C$	-	-	10	μA			
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	100	nA			
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	-100	nA			

ON CHARACTERISTICS (Note 2)

V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS},\ I_{D}=250\ \mu A$	1	1.6	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C	-	-4.2	-	mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			0.043 0.065 0.071	0.06 0.1 0.09	Ω
I _{D(on)}	On-State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V	5	-	_	А
g fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	-	5	_	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 15 V, V_{GS} = 0 V, f = 1.0 MHz	_	235	_	pF
C _{oss}	Output Capacitance		-	145	-	pF
C _{rss}	Reverse Transfer Capacitance		-	50	-	pF

SWITCHING CHARACTERISTICS (Note 2)

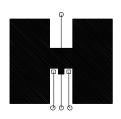
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	5	10	ns
t _r	Turn–On Rise Time	$R_{GEN} = 6 \ \Omega$	-	12	22	ns
t _{d(off)}	Turn–Off Delay Time		-	12	22	ns
t _f	Turn–Off Fall Time		-	3	8	ns
Qg	Total Gate Charge	V_{DS} = 10 V, I _D = 5 A, V _{GS} = 5 V	-	4.2	5.9	nC
Q _{gs}	Gate-Source Charge		-	1.3	-	nC
Q _{gd}	Gate-Drain Charge		-	1.7	-	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATIINGS

	۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	2.5	А
Γ	V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 2.5 \text{ A}$ (Note 2)	-	0.85	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. NOTES:

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 42°C/W when mounted on a 1 in² pad of 2oz Cu.



b. 95°C/W when mounted on a 0.066 in² pad of 2oz Cu.



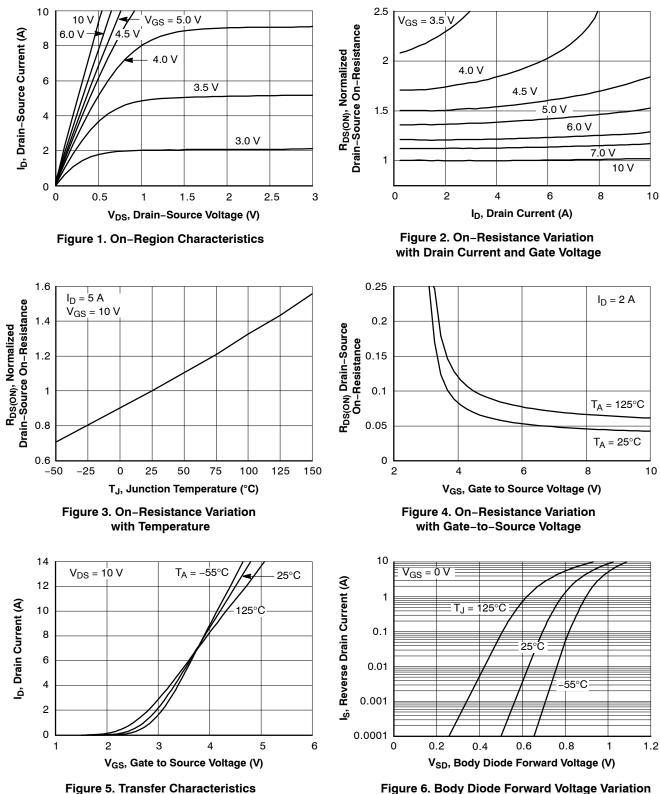
c. 110°C/W when mounted on a 0.00123 in² pad of 2oz Cu.

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 µs, Duty cycle \leq 2.0 %.

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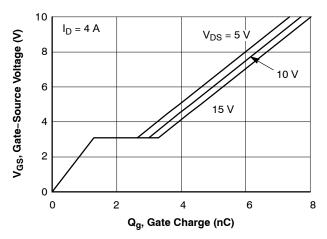
TYPICAL CHARACTERISTICS



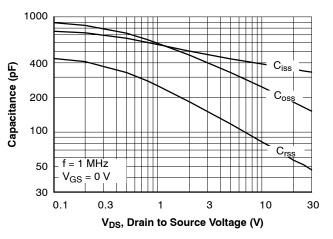


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TYPICAL ELECTRICAL CHARACTERISTICS (continued)









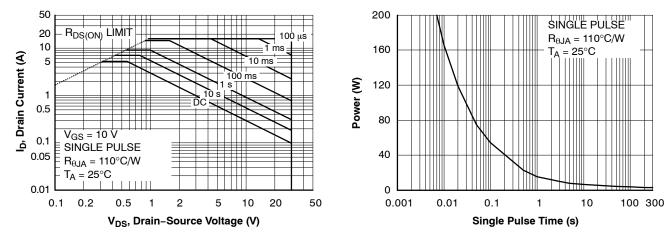
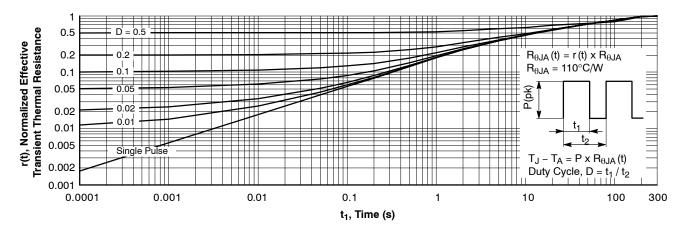
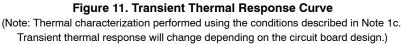


Figure 9. Maximum Safe Operating Area

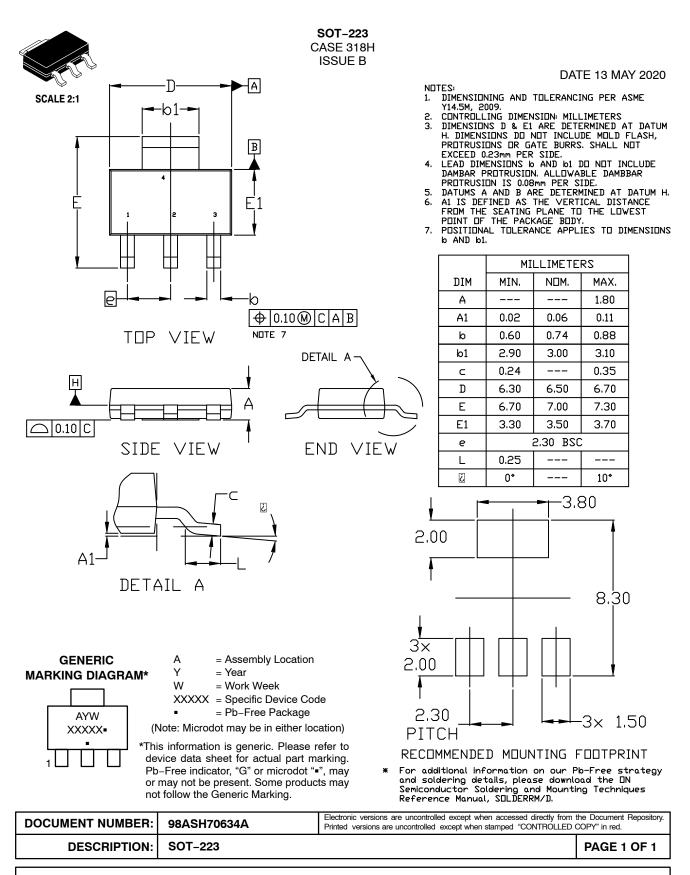






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PACKAGE DIMENSIONS



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